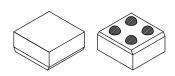
MECHANICAL CASE OUTLINE

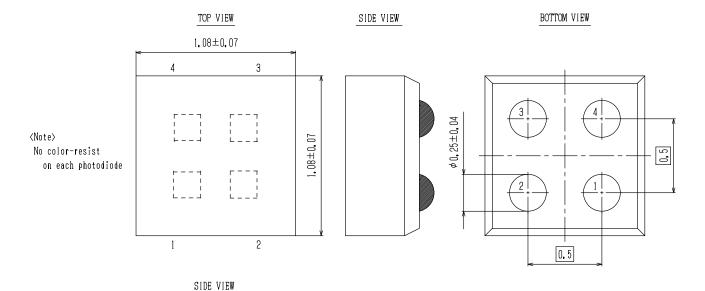
PACKAGE DIMENSIONS

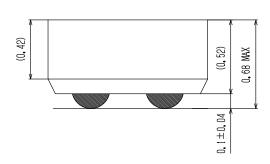




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DATE 31 MAR 2012





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